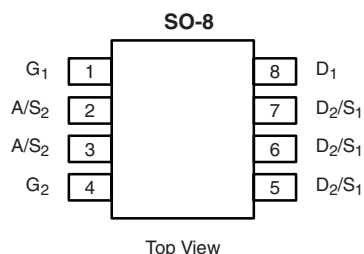


Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY			
	V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
Channel-1	30	0.022 at V _{GS} = 10 V	6.3
		0.030 at V _{GS} = 4.5 V	5.4
Channel-2		0.013 at V _{GS} = 10 V	10
		0.0185 at V _{GS} = 4.5 V	8.6

SCHOTTKY PRODUCT SUMMARY		
V _{DS} (V)	V _{SD} (V) Diode Forward Voltage	I _F (A)
30	0.50 V at 1.0 A	2.0



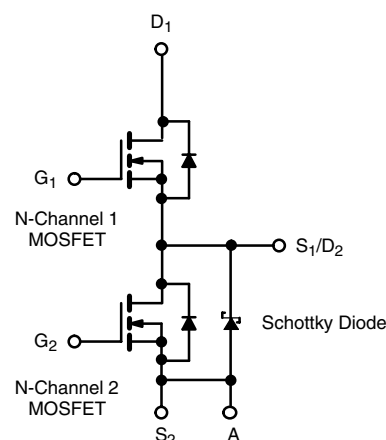
Ordering Information: Si4816DY-T1-E3 (Lead (Pb)-free)
Si4816DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- LITTLE FOOT® Plus Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE
Available



ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Parameter		Symbol	Channel-1		Channel-2		Unit
			10 s	Steady State	10 s	Steady State	
Drain-Source Voltage		V _{DS}	30				V
Gate-Source Voltage		V _{GS}	20				
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	6.3	5.3	10	7.7	A
	T _A = 70 °C		5.4	4.2	8.2	6.2	
Pulsed Drain Current		I _{DM}	30		40		
Continuous Source Current (Diode Conduction) ^a		I _S	1.3	0.9	2.2	1.15	
Avalanche Current ^b	L = 0.1 mH	I _{AS}	12		25		mJ
Single Pulse Avalanche Energy ^b		E _{AS}	7.2		31.25		
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	1.4	1.0	2.4	1.25	W
	T _A = 70 °C		0.9	0.64	1.5	0.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C

THERMAL RESISTANCE RATINGS									
Parameter	t ≤ 10 s	Symbol	Channel-1		Channel-2		Schottky		Unit
			Typ.	Max.	Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient ^a	Steady State	R _{thJA}	72	90	43	53	48	60	°C/W
	Steady State	R _{thJC}	51	63	25	30	28	35	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Starting date code W46BAA.

MOSFET SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions		Min.	Typ. ^a	Max.	Unit
Static							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	Ch-1	0.8		2	V
			Ch-2	1.0		3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V	Ch-1			100	nA
			Ch-2			100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	Ch-1			1	μA
			Ch-2			100	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 85 °C	Ch-1			15	
			Ch-2			2000	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	Ch-1	20			A
			Ch-2	30			
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 6.3 A	Ch-1		0.018	0.022	Ω
		V _{GS} = 10 V, I _D = 10 A	Ch-2		0.0105	0.013	
		V _{GS} = 4.5 V, I _D = 5.4 A	Ch-1		0.024	0.030	
		V _{GS} = 4.5 V, I _D = 8.6 A	Ch-2		0.015	0.0185	
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 6.3 A	Ch-1		17		S
		V _{DS} = 15 V, I _D = 10 A	Ch-2		28		
Diode Forward Voltage ^b	V _{SD}	I _S = 1.3 A V, V _{GS} = 0 V	Ch-1		0.7	1.1	V
		I _S = 1 A V, V _{GS} = 0 V	Ch-2		0.47	0.5	
Dynamic ^a							
Total Gate Charge	Q _g	Channel-1 V _{DS} = 15 V, V _{GS} = 5 V, I _D = 6.3 A	Ch-1		8.0	12	nC
			Ch-2		15	23	
Gate-Source Charge	Q _{gs}		Ch-1		1.75		
			Ch-2		5.3		
Gate-Drain Charge	Q _{gd}	Channel-2 V _{DS} = 15 V, V _{GS} = 5 V, I _D = - 10 A	Ch-1		3.2		
			Ch-2		4.6		
Gate Resistance	R _g		Ch-1	1.5		6.1	Ω
			Ch-2	0.5		2.6	
Turn-On Delay Time	t _{d(on)}	Channel-1 V _{DD} = 15 V, R _L = 15 Ω I _D ≡ 1 A, V _{GEN} = 10 V, R _g = 6 Ω	Ch-1		10	20	ns
			Ch-2		15	30	
Rise Time	t _r		Ch-1		5	10	
			Ch-2		5	10	
Turn-Off Delay Time	t _{d(off)}	Channel-2 V _{DD} = 15 V, R _L = 15 Ω I _D ≡ 1 A, V _{GEN} = 10 V, R _g = 6 Ω	Ch-1		26	50	
			Ch-2		44	80	
Fall Time	t _f		Ch-1		8	16	
			Ch-2		12	24	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.3 A, dI/dt = 100 A/μs	Ch-1		30	60	
		I _F = 2.2 A, dI/dt = 100 μA/μs	Ch-2		32	70	

Notes:

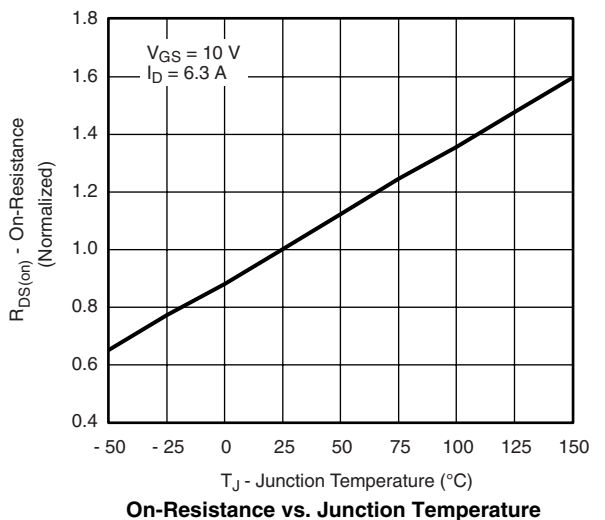
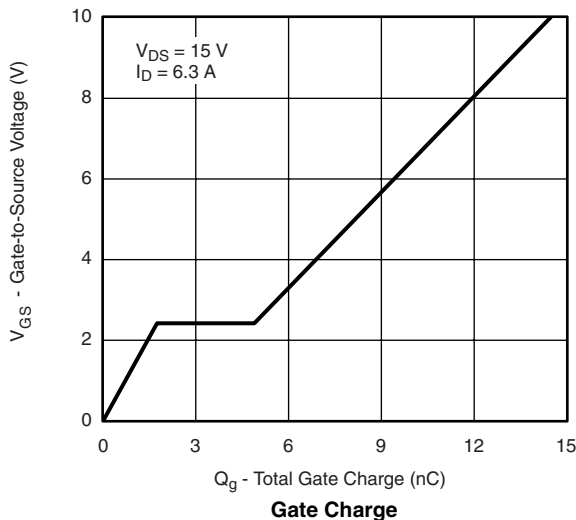
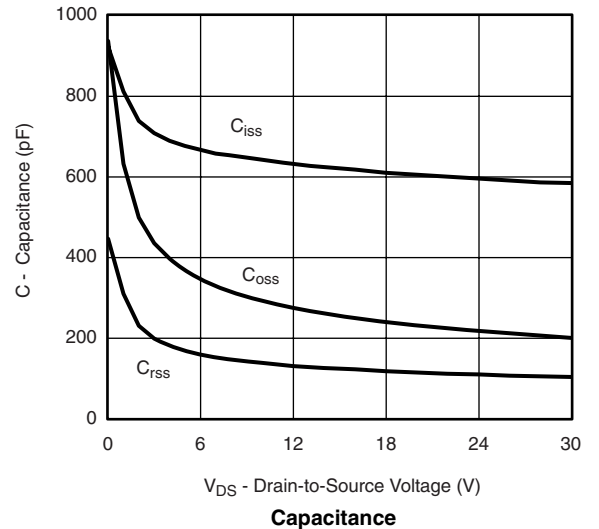
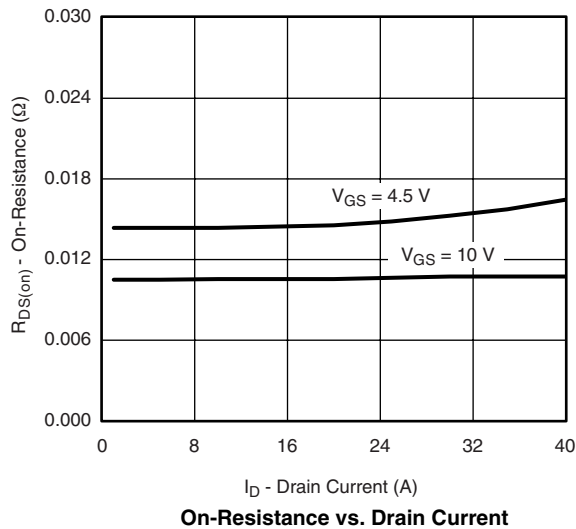
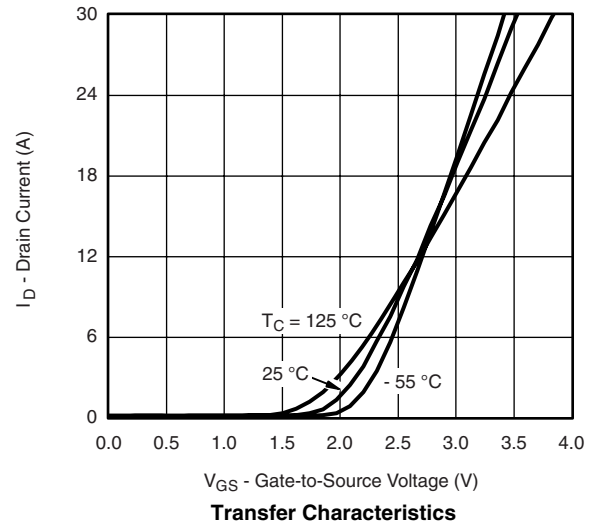
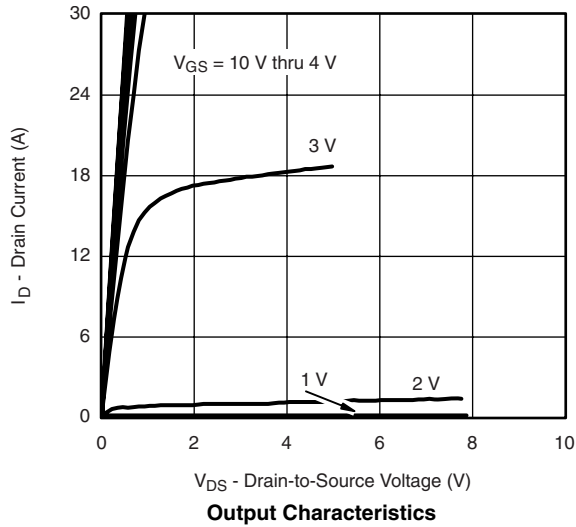
a. Guaranteed by design, not subject to production testing.

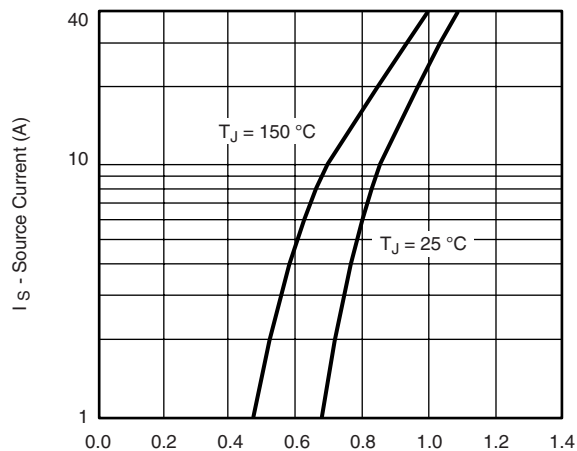
b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

SCHOTTKY SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	V_F	$I_F = 1.0\text{ A}$		0.47	0.50	V
		$I_F = 1.0\text{ A}, T_J = 125\text{ }^\circ\text{C}$		0.36	0.42	
Maximum Reverse Leakage Current	I_{rm}	$V_R = 30\text{ V}$		0.004	0.100	mA
		$V_R = 30\text{ V}, T_J = 100\text{ }^\circ\text{C}$		0.7	10	
		$V_R = -30\text{ V}, T_J = 125\text{ }^\circ\text{C}$		3.0	20	
Junction Capacitance	C_T	$V_R = 10\text{ V}$		50		pF

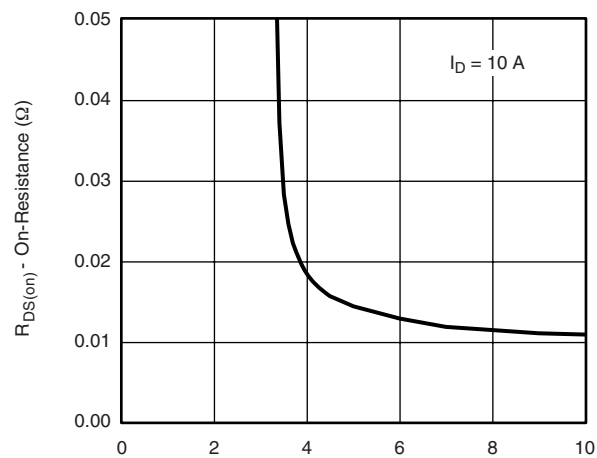
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

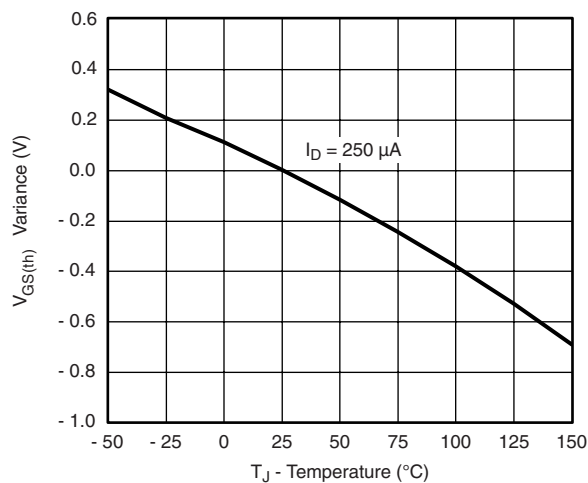


CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

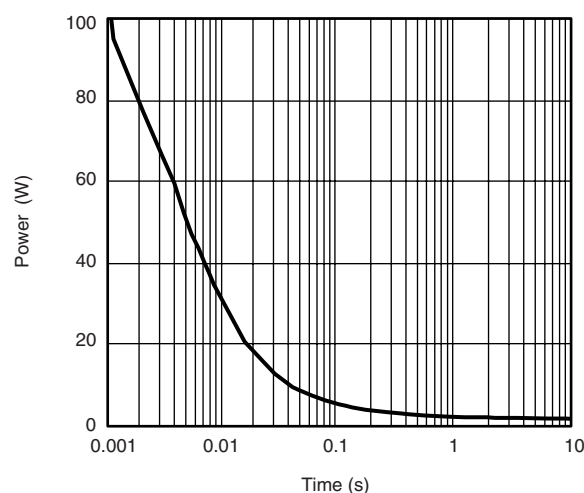
Source-Drain Diode Forward Voltage



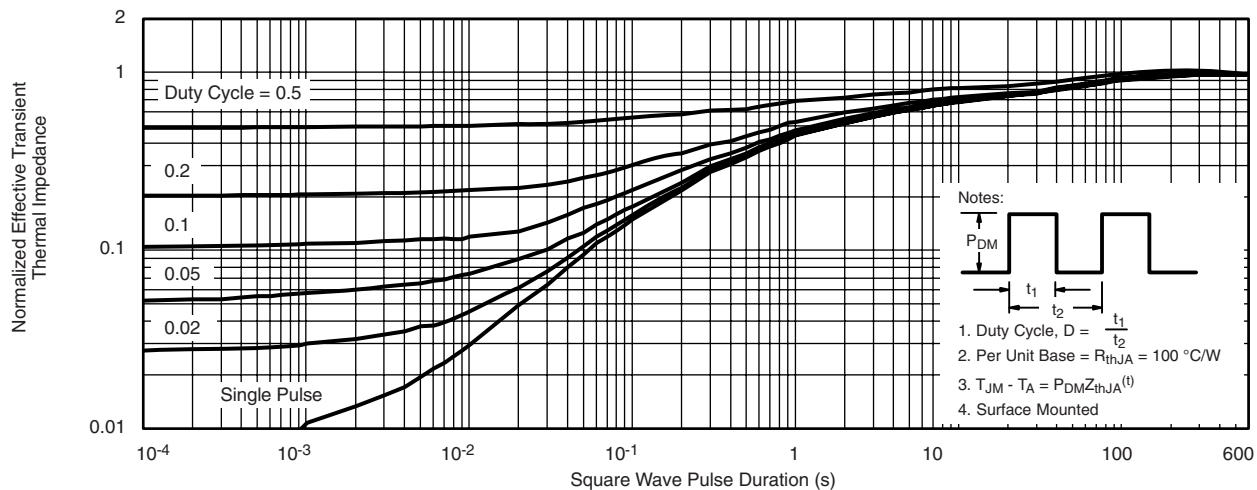
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

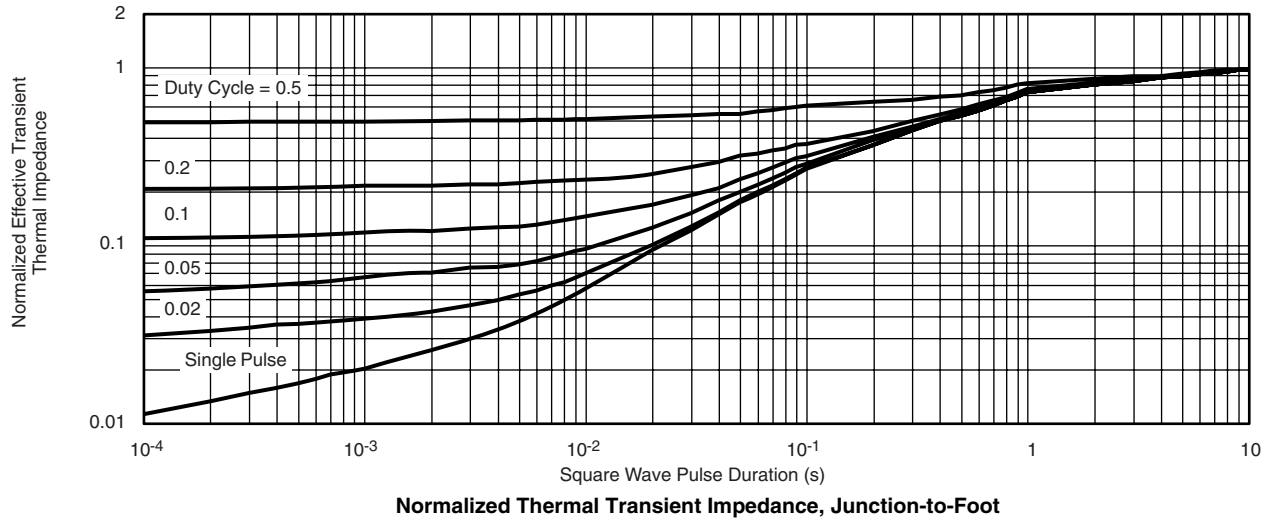


Single Pulse Power, Junction-to-Ambient

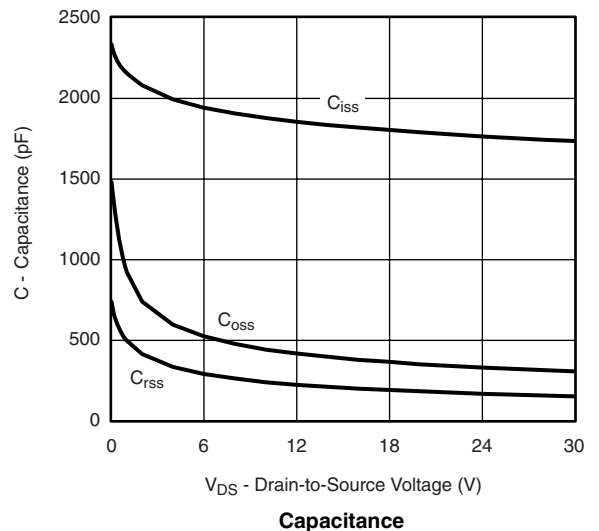
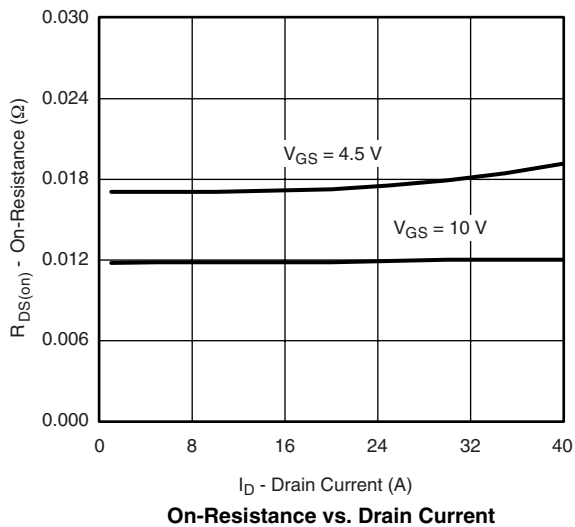
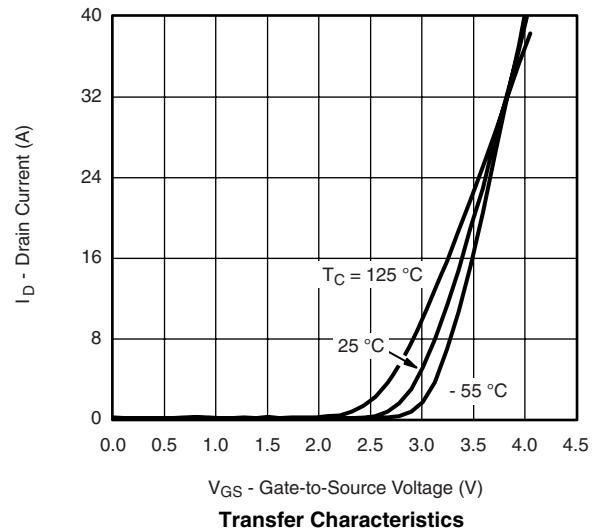
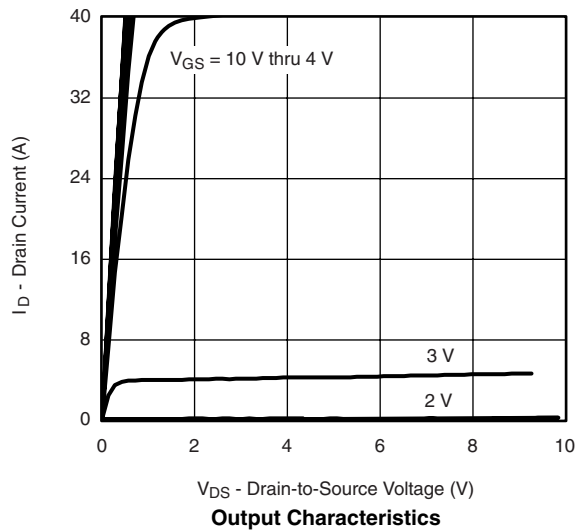


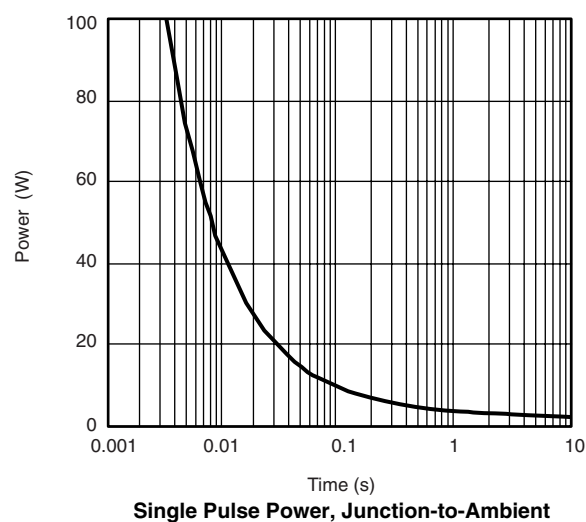
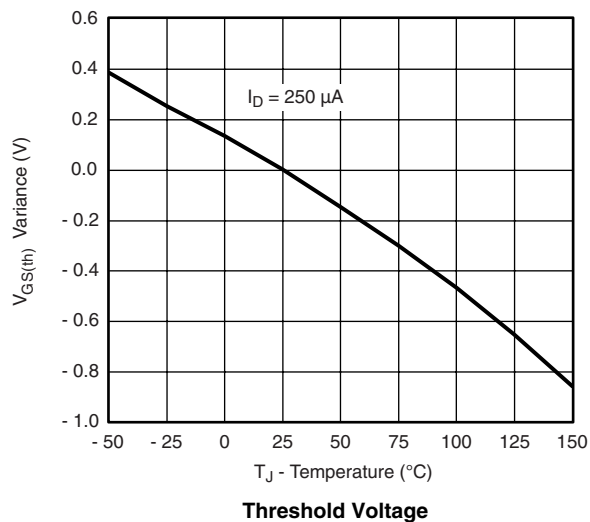
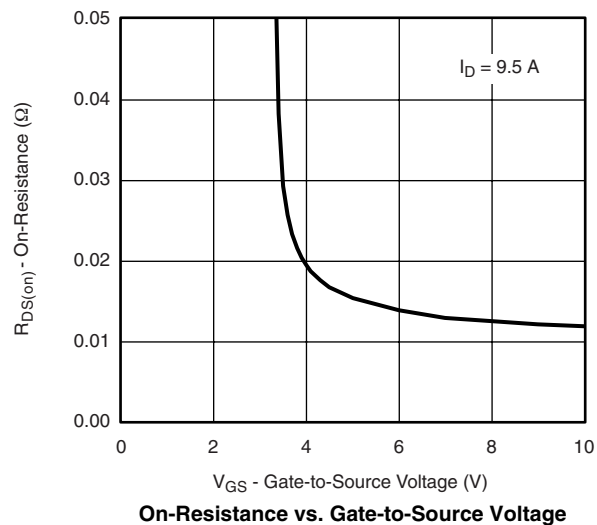
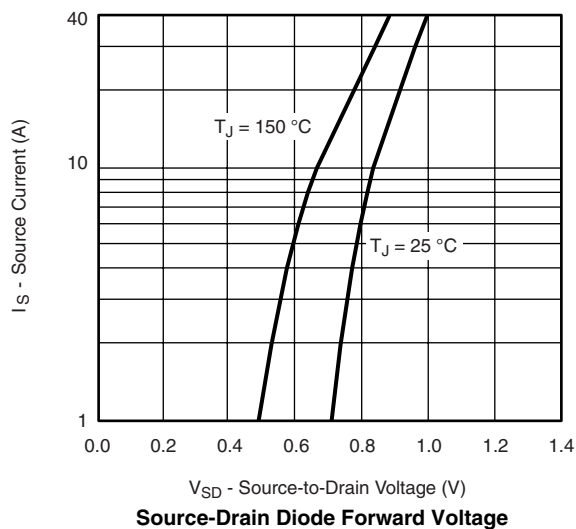
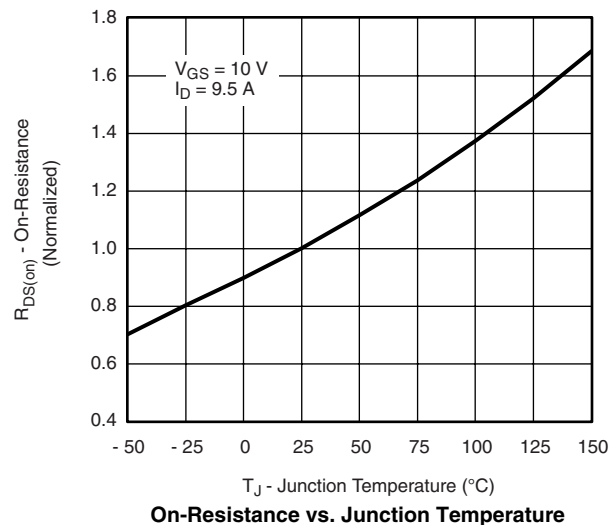
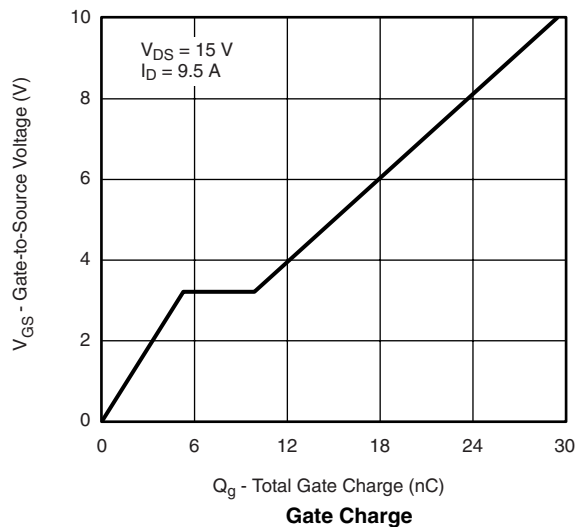
Normalized Thermal Transient Impedance, Junction-to-Ambient

CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

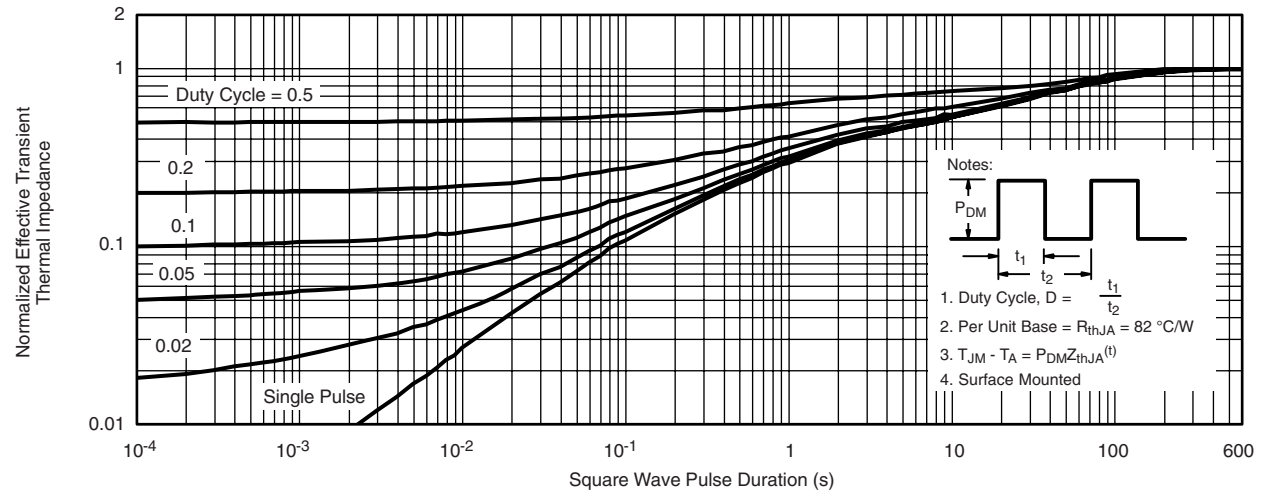


CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

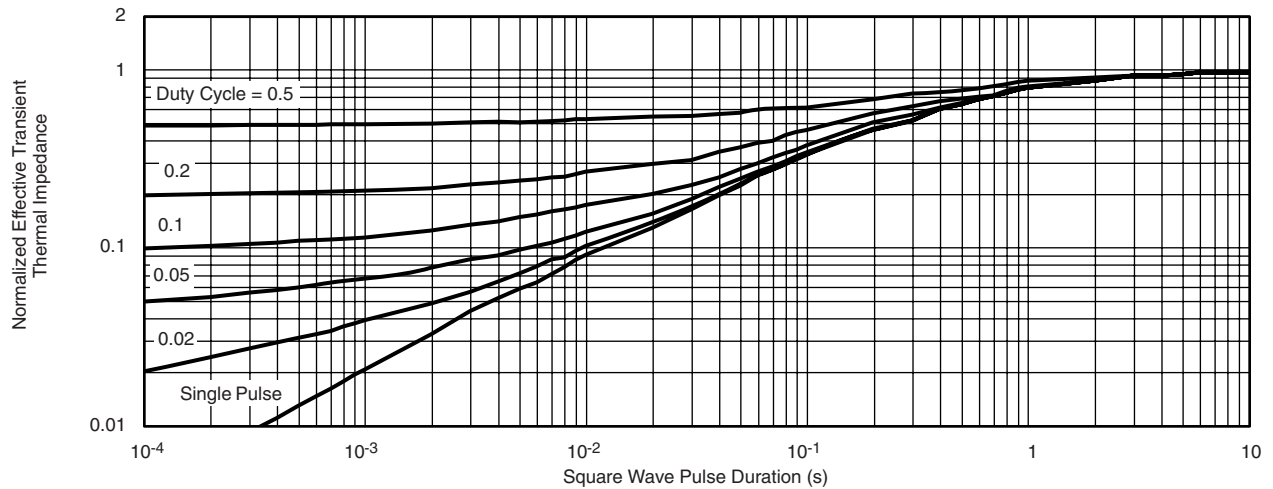


CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

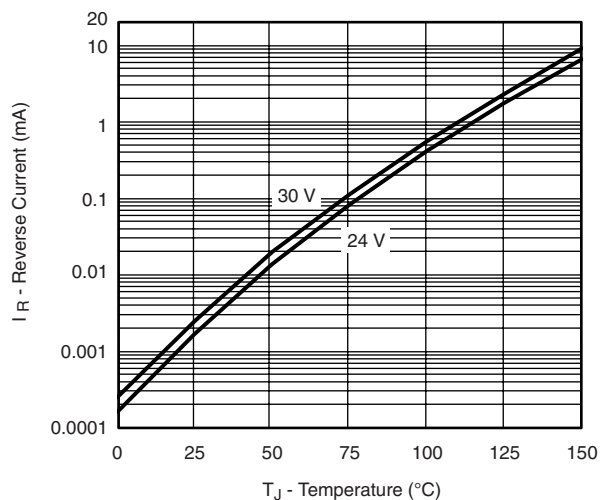
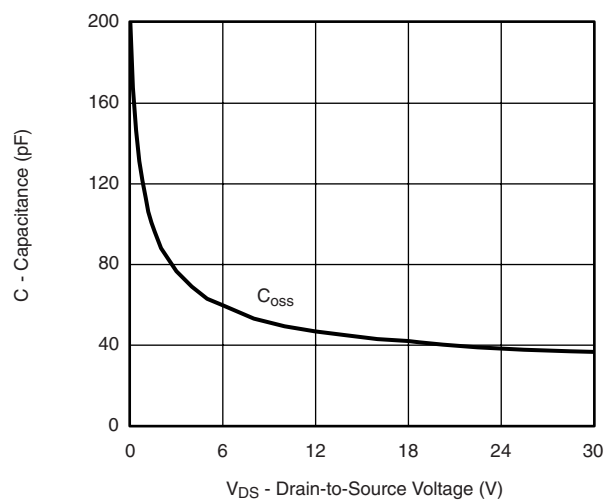
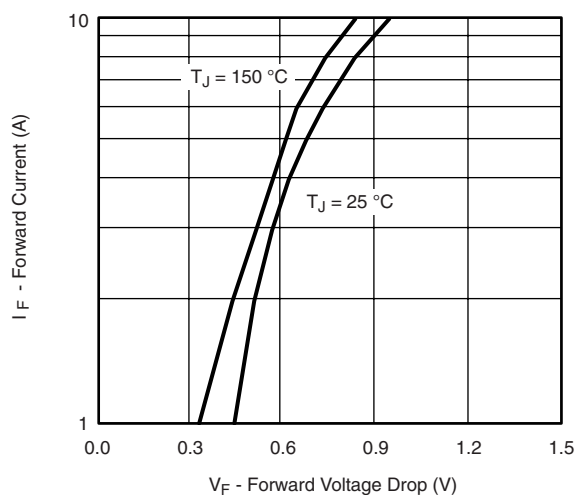
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

SCHOTTKY TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted**Reverse Current vs. Junction Temperature****Capacitance****Forward Voltage Drop**

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